

标 记 MARK	ECN编号/变更内容 ECN NO/DEFINITION	修 改 REVISE	日 期 DATE	核 准 APPROVE

A

B

C

D

E

F

G

A

B

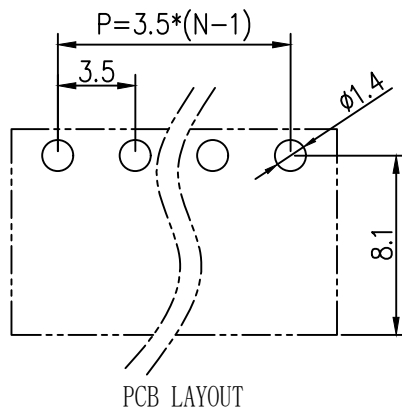
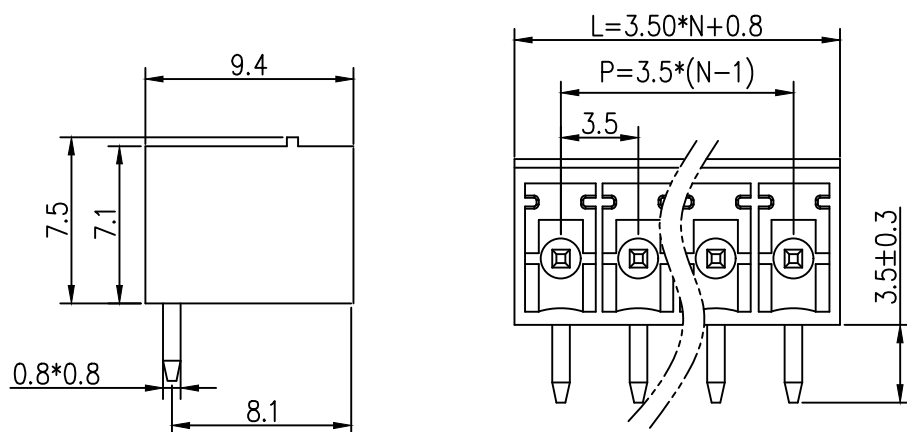
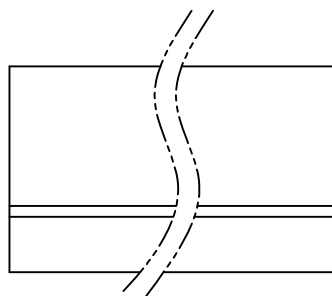
C

D

E

F

G



PCB LAYOUT

Materials and Electroplating

- ①. Plastic body: PA66,
- ②. Solder pin: copper, Nickel tin plating

Electrical performance

Rated voltage: 300V

Rated current: 8A

Contact resistance: 20m Ω (Max)

Insulation resistance: 500M Ω \ DC500V

Voltage endurance: AC1500V \ 1min

mechanical properties

Temperature range: -40 ℃~+105 ℃

Instantaneous temperature: +250 ℃, 5 seconds

2	插针	铜	镀镍锡	
1	基座	PA66	绿色	
序号	品名	材质	电镀/颜色	备注

	深圳市虹成电子有限公司		品名 TITLE	接线端子	
			料号 PART NO	HC-JXDZRC-3.5-16P	
GENERAL TOLERANCES (UNLESS SPECIFIED)		比列 SCALE	1:1		
公差参数		单位 UNIT	MM	制图 DRAW	AhYe
2-6P ±0.10 ±0.20 X.X ±0.35		张数 PART NO	1 OF 1	审核 CHECKED	夏操云
7-12P ±0.20 ±0.30 X.XX ±0.25		版本 REV	A	批准 APPROVE	赵亮亮
13-18P ±0.25 ±0.40 X.XXX ±0.15					
19-24P ±0.30 ±0.50 X.XXX ±0.15					